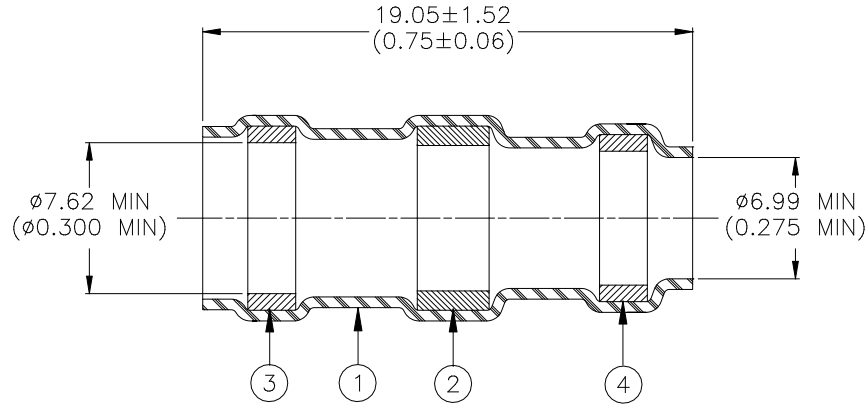


CUSTOMER DRAWING

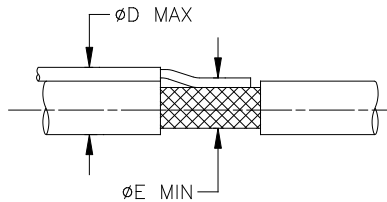


MATERIALS


1. **INSULATION SLEEVE:** Heat-shrinkable, transparent blue, radiation cross-linked modified polyvinylidene fluoride.
2. **SOLDER PREFORM WITH FLUX:**
 SOLDER: TYPE Sn63 per ANSI J-STD-006.
 FLUX: TYPE ROM 1 per ANSI-J-STD-004.
3. **MELTABLE RING:** Thermally stabilized thermoplastic, color-blue.
4. **MELTABLE RING:** Thermally stabilized thermoplastic, color-natural.

APPLICATION

1. This part is designed for termination of nickel plated copper shields on cables having insulations rated for 125°C.
2. Part may be used on cables having a maximum “D” diameter of 7.62 (0.300) and a minimum “E” diameter of 4.06 (0.160) when measured as shown.



3. This part will meet the requirements of Raychem Specification RT-1404.
4. For assembly technique, see RCPS 100-70.

		Raychem THERMOFIT DEVICES		TITLE: SOLDERSLEEVE HIGH TEMPERATURE HIGH FLUX CONTENT (FOR NICKEL WIRE) 7.62 (0.30) I.D.		
Unless otherwise specified dimensions are in millimeters. [Inches dimensions are shown in brackets]				DOCUMENT NO.: D-103-54		
TOLERANCES: 0.00 N/A 0.0 N/A 0 N/A	ANGLES: N/A ROUGHNESS IN MICRON	TE Connectivity reserves the right to amend this drawing at any time. Users should evaluate the suitability of the product for their application.		REV : 2	DATE : 17-APR-2020	
DRAWN BY: M. FORONDA	DATE: 06-JUL-00	ECO: ECO-20-005247	SCALE: NTS	SIZE: A	SHEET: 1 of 1	

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